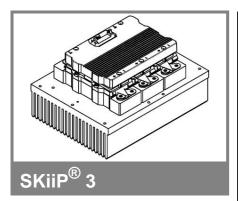
SKiiP 313GD122-3DUL



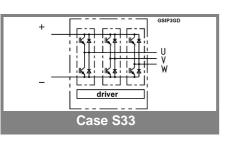
6-pack-integrated intelligent Power System

Power Section SKiiP 313GD122-3DUL

Preliminary Data

Features

- · SKiiP technology inside
- SPT (Soft Punch Through) IGBTs
- CAL diode technology
- Integrated current sensor
- Integrated temperature sensor
- Integrated heat sink
- IEC 60721-3-3 (humidity) class 3K3/IE32 (SKiiP[®] 3 System)
- IEC 68T.1 (climate) 40/125/56 (SKiiP[®] 3 power section)
- UL recognized File no. E63532 (SKiiP[®] 3 power section)
- with assembly of suitable MKP capacitor per terminal (SEMIKRON type is recommended)

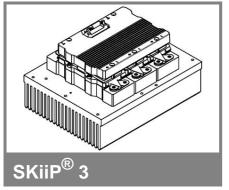


Absolute	Maximum Ratings T	s = 25 °C unless otherwise specified				
Symbol	Conditions	Values	Units			
IGBT						
V _{CES} V _{CC} 1)		1200	V			
V _{CC} 1)	Operating DC link voltage	900	V			
V_{GES}		± 20	V			
I _C	T _s = 25 (70) °C	300 (225)	Α			
Inverse diode						
I _F = - I _C	T _s = 25 (70) °C	230 (180)	Α			
I _{FSM}	$T_{j} = 150 ^{\circ}\text{C}, t_{p} = 10 \text{ms}; \text{sin}$	2880	Α			
I ² t (Diode)	Diode, T _j = 150 °C, 10 ms	23	kA²s			
T _i , (T _{stq})		- 40 + 150 (125)	°C			
V _{isol}	rms, AC, 1 min, main terminals to heat sink	3000	V			
I _{AC-terminal}	per AC terminal, rms, T _s = 70 °C,	400	Α			
	T _{terminal} <115 °C					

Characteristics				T _s = 25 °C unless otherwise specified				
Symbol Conditions				min.	typ.	max.	Units	
IGBT	•							
V _{CEsat}	I _C = 193 A measured at t	, T _j = 25 (1 terminal	25) °C;			2,3 (2,5)	2,6	V
V_{CEO}		25) °C; at to				1,1 (1)	1,3 (1,2)	V
r _{CE}		25) °C; at to				6 (7,8)	7 (8,8)	mΩ
I _{CES}	$V_{GE} = 0 V_1$ $T_1 = 25 (12)$, V _{CE} = V _{CI} 25) °C	ES [,]			0,6 (18)		mA
E _{on} + E _{off}	I _C = 193 A		0 V			58		mJ
	T _j = 125 °(C, V _{CC} = 90	00 V			102		mJ
R _{CC+EE}	terminal cl	hip, T _j = 25	5 °C			0,5		mΩ
L _{CE}	top, bottor	'n				12		nΗ
C _{CHC}	per phase	, AC-side				1,7		nF
Inverse o	diode							
$V_F = V_{EC}$	I _F = 193 A measured at t	., T _j = 25 (1 terminal	25) °C			2 (1,8)	2,3	V
V_{TO}	T _i = 25 (12	25) °C				1 (0,7)	1,2 (0,9)	V
r _T	$T_i = 25 (12)$	25) °C				5,3 (5,6)	7 (7,4)	mΩ
E _{rr}	I _C = 193 A	$V_{CC} = 60$	0 V			15		mJ
	T _j = 125 °0	$C, V_{CC} = 90$	00 V			20		mJ
Mechani	cal data							
M _{dc}		als, SI Uni			6		8	Nm
M _{ac}		als, SI Unit			13		15	Nm
W		System w/o	heat sink			2,4		kg
W	heat sink					7,5		kg
	e to heat					SKF 16B- nperature		
R _{th(j-s)I}	per IGBT						0,092	K/W
R _{th(j-s)D}	per diode						0,23	K/W
Z _{th}	R _i (mK/W) (max. values)				tau	_i (s)		
	1	2	3	4	1	2	3	4
$Z_{th(j-r)I}$								
$Z_{\text{th(j-r)D}}$ $Z_{\text{th(r-a)}}$	2,1	20	5,5	1,4	210	85	11	0,4

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SKiiP 313GD122-3DUL



Absolute Maximum Ratings					
Symbol	Conditions	Values	Units		
V_{S2}	unstabilized 24 V power supply	30	V		
V_{i}	input signal voltage (high)	15 + 0,3	V		
dv/dt	secondary to primary side	75	kV/μs		
V_{isollO}	input / output (AC, rms, 2)	3000	V		
V _{isolPD}	partial discharge extinction voltage, rms, Q _{PD} ≤10 pC;	1170	V		
V _{isol12}	output 1 / output 2 (AC, rms, 2 s)	1500	V		
f	switching frequency	20	kHz		
$T_{op} (T_{stg})$	operating / storage temperature	- 40 + 85	°C		

6-pack-integrated intelligent Power System

6-pack integrated gate driver SKiiP 313GD122-3DUL

Preliminary Data

Gate driver features

- CMOS compatible inputs
- Wide range power supply
- Integrated circuitry to sense phase current, heat sink temperature and

DC-bus voltage (option)

- Short circuit protection
- Over current protection
- Over voltage protection (option)
- Power supply protection against under voltage
- · Interlock of top/bottom switch
- · Isolation by transformers
- Fibre optic interface (option for GB-types only)
- IEC 68T.1 (climate) 40/85/56 (SKiiP[®] 3 gate driver)

Characte	eristics	(T _a = 25 °C)			= 25 °C)
Symbol	Conditions	min.	typ.	max.	Units
V_{S2}	supply voltage non stabilized	13	24	30	V
I _{S2}	V _{S2} = 24 V	365+20*f/kHz+0,00111*(I _{AC} /A) ²			mA
V _{iT+}	input threshold voltage (High)	11,2			V
V_{iT-}	input threshold voltage (Low)			5,4	V
R _{IN}	input resistance		10		kΩ
C _{IN}	input capacitance		1		nF
t _{d(on)IO}	input-output turn-on propagation time		1,3		μs
t _{d(off)IO}	input-output turn-off propagation time		1,3		μs
tpERRRESET	error memory reset time		9		μs
t _{TD}	top / bottom switch interlock time		3,3		μs
l analogOUT	max. 5mA; 8 V corresponds to 15 V supply		300		Α
	voltage for external components				
I _{s1out}	max. load current			50	mA
I _{TRIPSC}	over current trip level				
	(I _{analog} OUT = 10 V)		375		Α
T_tp	over temperature protection	110		120	°C
UDCTRIP	U _{DC} -protection (U _{analog OUT} = 9 V);		900		V
	(option for GB types)				

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